



30V COMPLEMENTARY ENHANCEMENT MODE MOSFET H-BRIDGE

Product Summary

Device	BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
N Channal	201/	$25m\Omega$ @ $V_{GS} = 10V$	6.0A
N-Channel	30V	$40m\Omega$ @ $V_{GS} = 4.5V$	4.6A
D. Okassa al	001/	$50m\Omega$ @ $V_{GS} = -10V$	-4.2A
P-Channel -30V		$80m\Omega$ @ $V_{GS} = -4.5V$	-3.2A

Description

This new generation complementary MOSFET H-Bridge features low on-resistance achievable with low gate drive.

Applications

- DC Motor Control
- DC-AC Inverters

Features

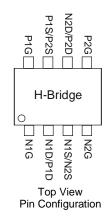
- 2 x N + 2 x P Channels in A SO-8 Package
- Low On-Resistance
- Low Input Capacitance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMHC3025LSDQ)

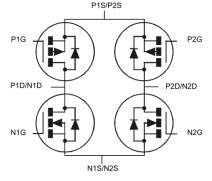
Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 [®]
- Weight: 0.008 grams (Approximate)









Internal Schematic

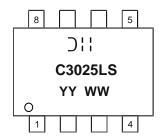
Ordering Information (Note 4)

Part Number	Case	Packaging
DMHC3025LSD-13	SO-8	2500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



⊃¦¦ = Manufacturer's Marking
 C3025LS = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Year (ex: 18 = 2018)
 WW = Week (01 to 53)



Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	1.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	83	
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	$R_{\theta JA}$	50	°C/W
Thermal Resistance, Junction to Case		R ₀ JC	14.5	
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C

Maximum Ratings N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Steady State		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	6.0 4.8	А
Continuous Drain Current (Note 5) V _{GS} = 10V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	7.8 6.1	А
Ste Si		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	4.6 3.6	А
Continuous Drain Current (Note 5) V _{GS} = 4.5V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	6.1 4.8	А
Maximum Continuous Body Diode Forward Current (Note 5)			I _S	2.5	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	60	А

Maximum Ratings P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V_{DSS}	30	V
Gate-Source Voltage			V_{GSS}	±20	V
State		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-4.2 -3.3	А
Continuous Drain Current (Note 5) V _{GS} = -10V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-5.4 -4.3	А
Continuous Drain Current (Note 5) // 45/	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-3.2 -2.5	Α
Continuous Drain Current (Note 5) V _{GS} = -4.5V t < 10s		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-4.3 -3.3	Α
Maximum Continuous Body Diode Forward Current (Note 5)			I _S	-2.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	-30	A

Note: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 6)								
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μΑ	$V_{DS} = 30V, V_{GS} = 0V$		
Gate-Source Leakage	I _{GSS}	_	_	±1	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 6)								
Gate Threshold Voltage	V _{GS(TH)}	1		2	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$		
Static Drain-Source On-Resistance	D	-	19	25	mΩ	$V_{GS} = 10V, I_D = 5A$		
Static Dialii-Source Off-Resistance	R _{DS(ON)}	-	26	40	11122	$V_{GS} = 4.5V, I_{D} = 4A$		
Forward Transfer Admittance	Y _{fs}	_	4	_	S	$V_{DS} = 5V, I_{D} = 5A$		
Diode Forward Voltage	V _{SD}	_	0.70	1.2	V	$V_{GS} = 0V, I_{S} = 1.7A$		
DYNAMIC CHARACTERISTICS (Note 7)	DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	C _{iss}	-	590	_				
Output Capacitance	Coss	_	122	_	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1MHz		
Reverse Transfer Capacitance	C _{rss}	_	58	_				
Gate Resistance	R_{g}	1	1.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.4	_				
Total Gate Charge (V _{GS} = 10V)	Qg	_	11.7	_	nC	V _{DS} = 15V. I _D = 7.8A		
Gate-Source Charge	Qgs	_	1.8	_	IIC	$V_{DS} = 15V, I_D = 7.6A$		
Gate-Drain Charge	Q_{gd}	_	2.1	_				
Turn-On Delay Time	t _{D(ON)}	_	11.2	_				
Turn-On Rise Time	t _R	_	15	_	20	$V_{DD} = 15V, V_{GS} = 4.5V,$		
Turn-Off Delay Time	t _{D(OFF)}	_	17.5	_	ns	$R_L = 2.4\Omega$, $R_G = 1\Omega$		
Turn-Off Fall Time	t _F	_	8.7	_				
Reverse Recovery Time	t _{RR}	_	18.3	_	ns	L 40A -11/-11 - 500A/		
Reverse Recovery Charge	Q_{RR}	_	12	_	nC	$I_F = 12A$, di/dt = 500A/ μ s		

Electrical Characteristics P-CHANNEL (@TA = +25°C, unless otherwise specified.)

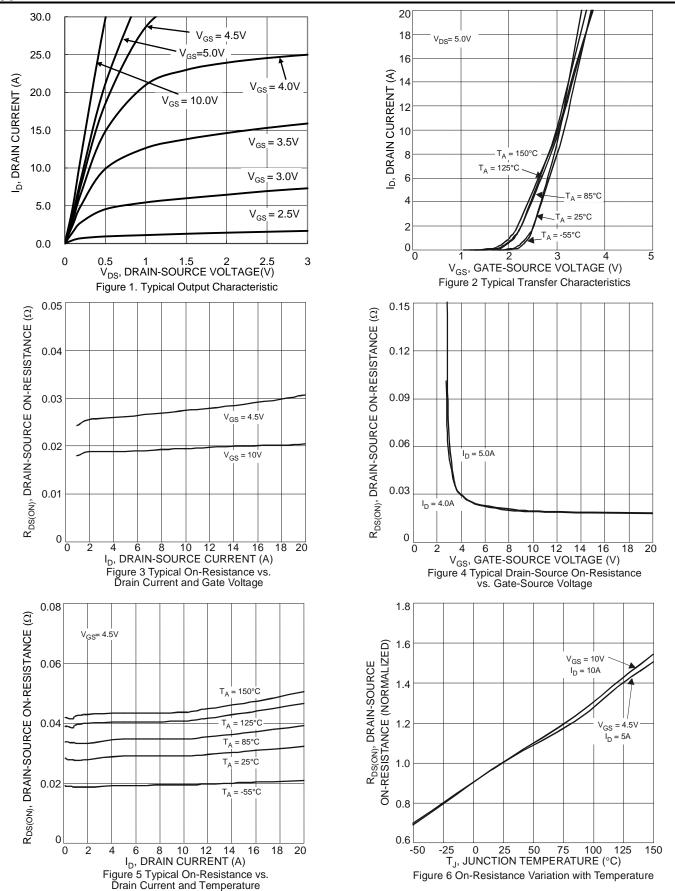
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	I	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}		1	-0.5	μΑ	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±1	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	$V_{GS(TH)}$	-1	-	-2	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
Static Drain-Source On-Resistance			43	50	mΩ	$V_{GS} = -10V, I_D = -5A$
Static Drain-Source On-Resistance	R _{DS(ON)}	l	68	80	11122	$V_{GS} = -4.5V$, $I_{D} = -4A$
Forward Transfer Admittance	Y _{fs}	_	3.5	_	S	$V_{DS} = -5V, I_{D} = -5A$
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1.7A$
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	C _{iss}		631	_	pF	451/11/ 01/
Output Capacitance	Coss	_	137	_	pF	V _{DS} = -15V, V _{GS} = 0V, -f = 1MHz
Reverse Transfer Capacitance	C _{rss}	_	70	_	pF	-I = IIVIHZ
Gate Resistance	R_g	_	10.8	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	5.5	_	nC	
Total Gate Charge (V _{GS} = -10V)	Qg	_	11.4	_	nC	1, 45,7,1 6,4
Gate-Source Charge	Q_{gs}	_	1.8	_	nC	$V_{DS} = -15V, I_{D} = -6A$
Gate-Drain Charge	Q _{qd}	_	2.4	_	nC	
Turn-On Delay Time	t _{D(ON)}		7.5	_	ns	
Turn-On Rise Time	t _R		4.9	_	ns	$V_{DD} = -15V, V_{GS} = -10V,$
Turn-Off Delay Time	t _{D(OFF)}		28.2	_	ns	$R_G = 6\Omega$, $I_D = -1A$
Turn-Off Fall Time	t _F		13.5	_	ns	1
Reverse Recovery Time	t _{RR}		15.1	_	ns	1 404 11/11 5004/5
Reverse Recovery Charge	Q _{RR}	_	15.3	_	nC	I _F = -12A, di/dt = 500A/μs

Notes: 6. Short duration pulse test used to minimize self-heating effect.

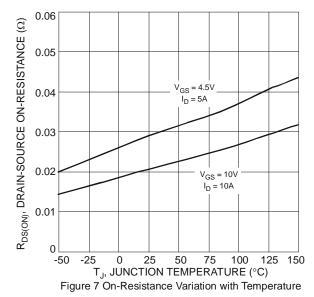
7. Guaranteed by design. Not subject to product testing.

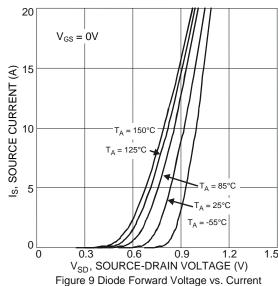


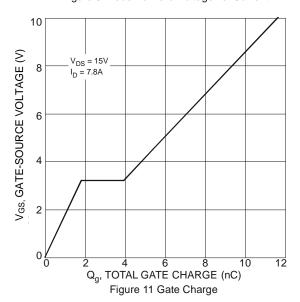
Typical Characteristics - N-CHANNEL











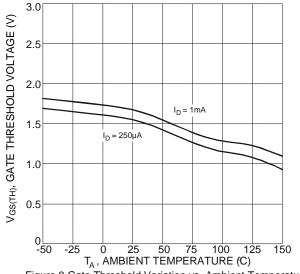
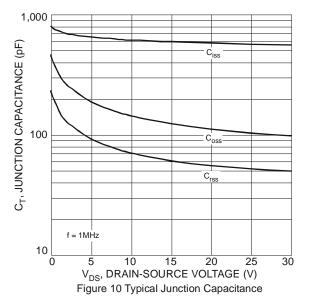
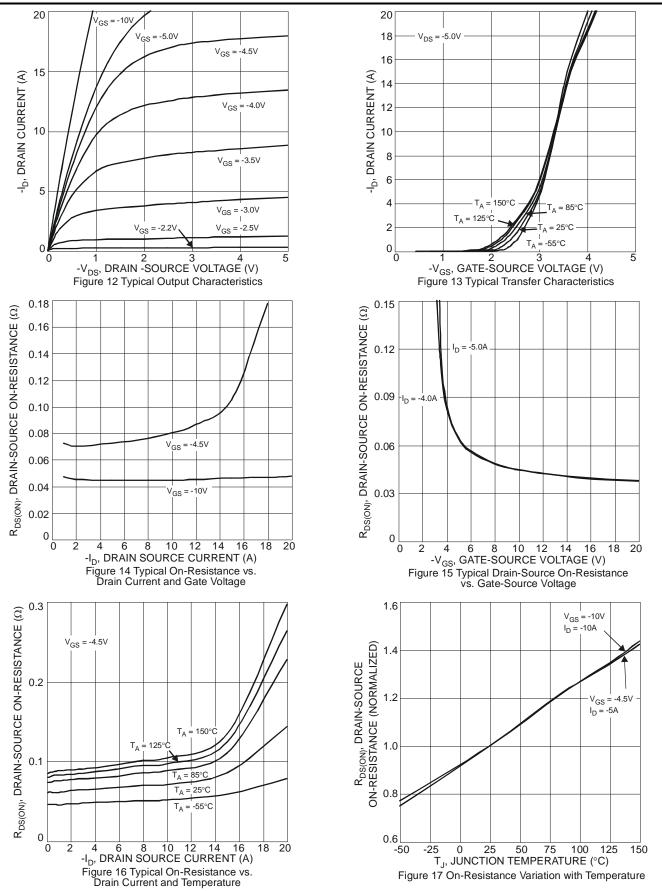


Figure 8 Gate Threshold Variation vs. Ambient Temperature





Typical Characteristics - P-CHANNEL







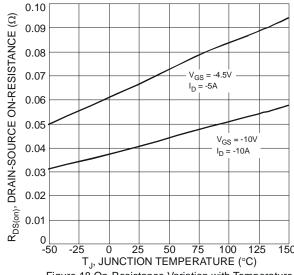
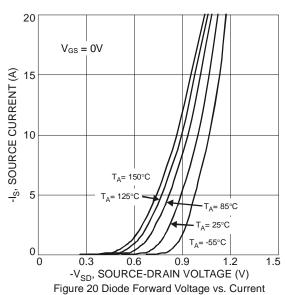
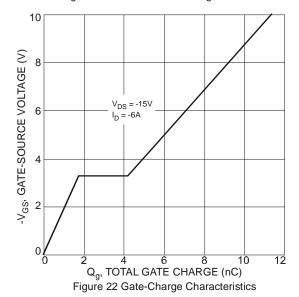


Figure 18 On-Resistance Variation with Temperature





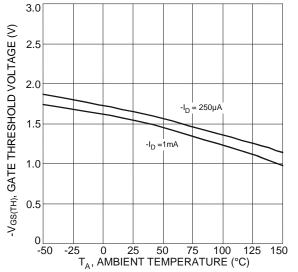
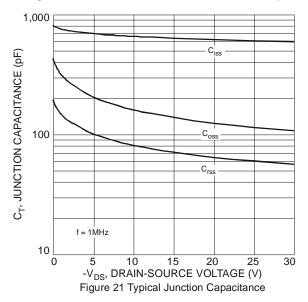


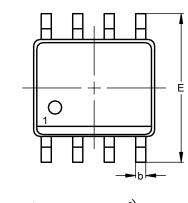
Figure 19 Gate Threshold Variation vs. Ambient Temperature

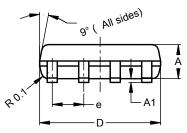


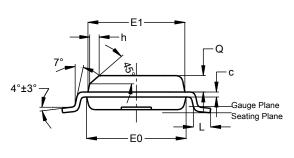


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.







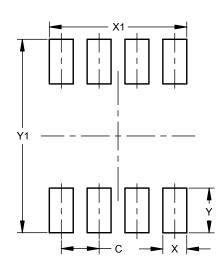
SO-8

SO-8							
Dim	Min	Max	Тур				
Α	1.40	1.50	1.45				
A 1	0.10	0.20	0.15				
b	0.30	0.50	0.40				
C	0.15	0.25	0.20				
D	4.85	4.95	4.90				
Е	5.90	6.10	6.00				
E1	3.80	3.90	3.85				
E0	3.85	3.95	3.90				
е			1.27				
h	-		0.35				
Г	0.62	0.82	0.72				
Q	0.60	0.70	0.65				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50



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